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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Obsolete
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, IrDA, LINbus, MMC/SD/SDIO, QSPI, SmartCard, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
Number of I/O	50
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b420f2048iq64-ar">https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b420f2048iq64-ar</a>

## 4.1.2.1 General Operating Conditions

Table 4.2. General Operating Conditions

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Operating ambient temperature range <sup>6</sup>	T <sub>A</sub>	-G temperature grade	-40	25	85	°C
		-I temperature grade	-40	25	125	°C
AVDD supply voltage <sup>2</sup>	V <sub>AVDD</sub>		1.8	3.3	3.8	V
VREGVDD operating supply voltage <sup>2 1</sup>	V <sub>VREGVDD</sub>	DCDC in regulation	2.4	3.3	3.8	V
		DCDC in bypass, 50mA load	1.8	3.3	3.8	V
		DCDC not in use. DVDD externally shorted to VREGVDD	1.8	3.3	3.8	V
VREGVDD current	I <sub>VREGVDD</sub>	DCDC in bypass, T ≤ 85 °C	—	—	200	mA
		DCDC in bypass, T > 85 °C	—	—	100	mA
DVDD operating supply voltage	V <sub>DVDD</sub>		1.62	—	V <sub>VREGVDD</sub>	V
IOVDD operating supply voltage	V <sub>IOVDD</sub>	All IOVDD pins <sup>5</sup>	1.62	—	V <sub>VREGVDD</sub>	V
DECOUPLE output capacitor <sup>3 4</sup>	C <sub>DECOUPLE</sub>		0.75	1.0	2.75	µF
HFCORECLK frequency	f <sub>CORE</sub>	VSCALE2, MODE = WS3	—	—	72	MHz
		VSCALE2, MODE = WS2	—	—	54	MHz
		VSCALE2, MODE = WS1	—	—	36	MHz
		VSCALE2, MODE = WS0	—	—	18	MHz
		VSCALE0, MODE = WS2	—	—	20	MHz
		VSCALE0, MODE = WS1	—	—	14	MHz
		VSCALE0, MODE = WS0	—	—	7	MHz
HFCLK frequency	f <sub>HFCLK</sub>	VSCALE2	—	—	72	MHz
		VSCALE0	—	—	20	MHz
HFSRCCLK frequency	f <sub>HFSRCCLK</sub>	VSCALE2	—	—	72	MHz
		VSCALE0	—	—	20	MHz
HFBUSCLK frequency	f <sub>HFBUSCLK</sub>	VSCALE2	—	—	50	MHz
		VSCALE0	—	—	20	MHz
HFPERCLK frequency	f <sub>HFPERCLK</sub>	VSCALE2	—	—	50	MHz
		VSCALE0	—	—	20	MHz
HFPERBCLK frequency	f <sub>HFPERBCLK</sub>	VSCALE2	—	—	72	MHz
		VSCALE0	—	—	20	MHz
HFPERCCLK frequency	f <sub>HFPERCCLK</sub>	VSCALE2	—	—	50	MHz
		VSCALE0	—	—	20	MHz

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Frequency limits	$f_{HFRCO\_BAND}$	FREQRANGE = 0, FINETUNIN-GEN = 0	1	—	10	MHz
		FREQRANGE = 3, FINETUNIN-GEN = 0	2	—	17	MHz
		FREQRANGE = 6, FINETUNIN-GEN = 0	4	—	30	MHz
		FREQRANGE = 7, FINETUNIN-GEN = 0	5	—	34	MHz
		FREQRANGE = 8, FINETUNIN-GEN = 0	7	—	42	MHz
		FREQRANGE = 10, FINETUNIN-GEN = 0	12	—	58	MHz
		FREQRANGE = 11, FINETUNIN-GEN = 0	15	—	68	MHz
		FREQRANGE = 12, FINETUNIN-GEN = 0	18	—	83	MHz
		FREQRANGE = 13, FINETUNIN-GEN = 0	24	—	100	MHz
		FREQRANGE = 14, FINETUNIN-GEN = 0	28	—	119	MHz
		FREQRANGE = 15, FINETUNIN-GEN = 0	33	—	138	MHz
		FREQRANGE = 16, FINETUNIN-GEN = 0	43	—	163	MHz

**Note:**

1. Maximum DPLL lock time  $\approx 6 \times (M+1) \times t_{REF}$ , where  $t_{REF}$  is the reference clock period.

## 4.1.15 Analog Comparator (ACMP)

Table 4.23. Analog Comparator (ACMP)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Input voltage range	V <sub>ACMPIN</sub>	ACMPVDD = ACMPn_CTRL_PWRSEL <sup>1</sup>	—	—	V <sub>ACMPVDD</sub>	V
Supply voltage	V <sub>ACMPVDD</sub>	BIASPROG <sup>4</sup> ≤ 0x10 or FULL-BIAS <sup>4</sup> = 0	1.8	—	V <sub>VREGVDD_MAX</sub>	V
		0x10 < BIASPROG <sup>4</sup> ≤ 0x20 and FULLBIAS <sup>4</sup> = 1	2.1	—	V <sub>VREGVDD_MAX</sub>	V
Active current not including voltage reference <sup>2</sup>	I <sub>ACMP</sub>	BIASPROG <sup>4</sup> = 1, FULLBIAS <sup>4</sup> = 0	—	50	—	nA
		BIASPROG <sup>4</sup> = 0x10, FULLBIAS <sup>4</sup> = 0	—	306	—	nA
		BIASPROG <sup>4</sup> = 0x02, FULLBIAS <sup>4</sup> = 1	—	6.5	—	μA
		BIASPROG <sup>4</sup> = 0x20, FULLBIAS <sup>4</sup> = 1	—	74	TBD	μA
Current consumption of internal voltage reference <sup>2</sup>	I <sub>ACMPREF</sub>	VLP selected as input using 2.5 V Reference / 4 (0.625 V)	—	50	—	nA
		VLP selected as input using VDD	—	20	—	nA
		VBDIV selected as input using 1.25 V reference / 1	—	4.1	—	μA
		VADIV selected as input using VDD/1	—	2.4	—	μA

## 4.1.17 Current Digital to Analog Converter (IDAC)

Table 4.25. Current Digital to Analog Converter (IDAC)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Number of ranges	N <sub>IDAC_RANGES</sub>		—	4	—	ranges
Output current	I <sub>IDAC_OUT</sub>	RANGSEL <sup>1</sup> = RANGE0	0.05	—	1.6	μA
		RANGSEL <sup>1</sup> = RANGE1	1.6	—	4.7	μA
		RANGSEL <sup>1</sup> = RANGE2	0.5	—	16	μA
		RANGSEL <sup>1</sup> = RANGE3	2	—	64	μA
Linear steps within each range	N <sub>IDAC_STEPS</sub>		—	32	—	steps
Step size	SS <sub>IDAC</sub>	RANGSEL <sup>1</sup> = RANGE0	—	50	—	nA
		RANGSEL <sup>1</sup> = RANGE1	—	100	—	nA
		RANGSEL <sup>1</sup> = RANGE2	—	500	—	nA
		RANGSEL <sup>1</sup> = RANGE3	—	2	—	μA
Total accuracy, STEPSEL <sup>1</sup> = 0x10	ACC <sub>IDAC</sub>	EM0 or EM1, AVDD=3.3 V, T = 25 °C	TBD	—	TBD	%
		EM0 or EM1, Across operating temperature range	TBD	—	TBD	%
		EM2 or EM3, Source mode, RANGSEL <sup>1</sup> = RANGE0, AVDD=3.3 V, T = 25 °C	—	-2.7	—	%
		EM2 or EM3, Source mode, RANGSEL <sup>1</sup> = RANGE1, AVDD=3.3 V, T = 25 °C	—	-2.5	—	%
		EM2 or EM3, Source mode, RANGSEL <sup>1</sup> = RANGE2, AVDD=3.3 V, T = 25 °C	—	-1.5	—	%
		EM2 or EM3, Source mode, RANGSEL <sup>1</sup> = RANGE3, AVDD=3.3 V, T = 25 °C	—	-1.0	—	%
		EM2 or EM3, Sink mode, RANGSEL <sup>1</sup> = RANGE0, AVDD=3.3 V, T = 25 °C	—	-1.1	—	%
		EM2 or EM3, Sink mode, RANGSEL <sup>1</sup> = RANGE1, AVDD=3.3 V, T = 25 °C	—	-1.1	—	%
		EM2 or EM3, Sink mode, RANGSEL <sup>1</sup> = RANGE2, AVDD=3.3 V, T = 25 °C	—	-0.9	—	%
		EM2 or EM3, Sink mode, RANGSEL <sup>1</sup> = RANGE3, AVDD=3.3 V, T = 25 °C	—	-0.9	—	%

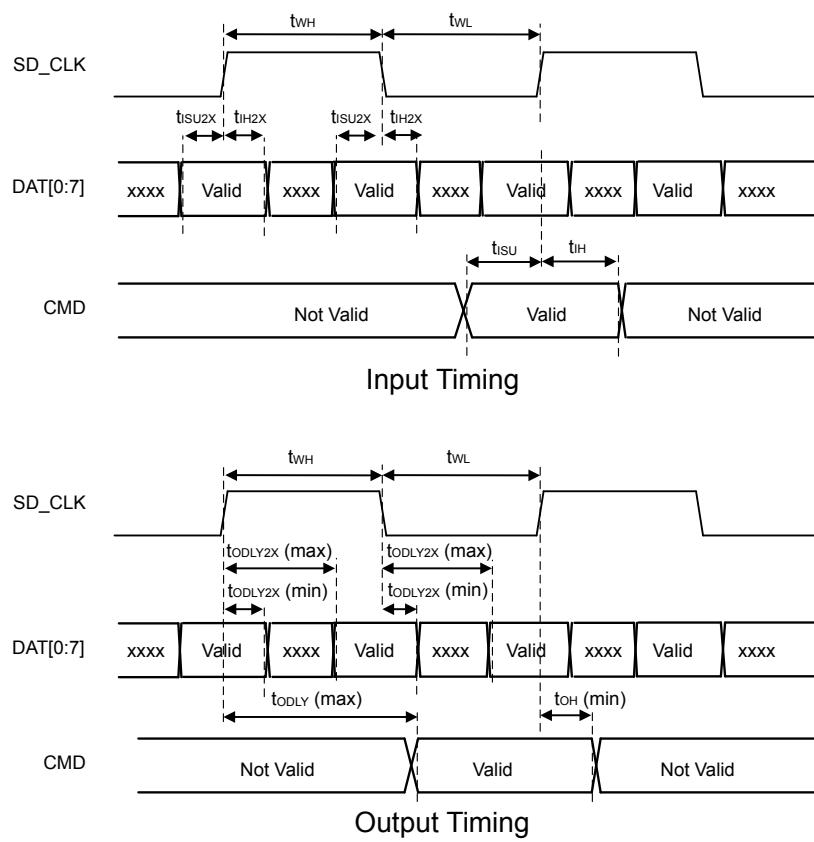
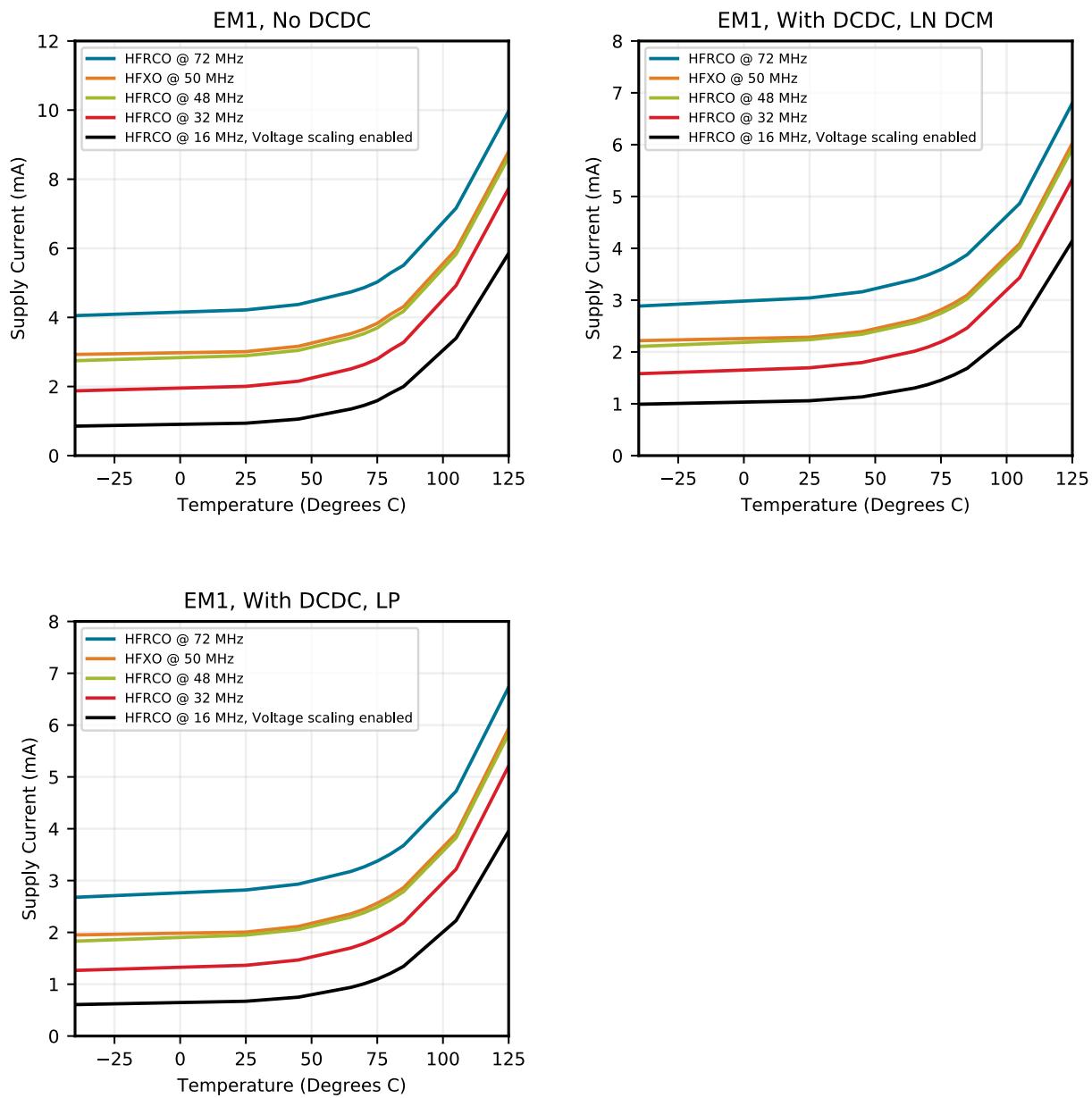


Figure 4.19. SDIO MMC DDR Mode Timing



**Figure 4.25. EM1 Sleep Mode Typical Supply Current vs. Temperature**

Typical supply current for EM2, EM3 and EM4H using standard software libraries from Silicon Laboratories.

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PG6	H1	GPIO (5V)	PG7	H2	GPIO (5V)
PG5	H3	GPIO (5V)	PE6	H12	GPIO
PE5	H13	GPIO	DVDD	H14	Digital power supply.
PG9	J1	GPIO (5V)	PG10	J2	GPIO (5V)
PG8	J3	GPIO (5V)	PE3	J12	GPIO
PE4	J13	GPIO	VREGVDD	J14	Voltage regulator VDD input
PG12	K1	GPIO	PG13	K2	GPIO
PG11	K3	GPIO (5V)	PE2	K12	GPIO
PE1	K13	GPIO (5V)	VREGSW	K14	DCDC regulator switching node
PG15	L1	GPIO (5V)	PB15	L2	GPIO (5V)
PG14	L3	GPIO	PC7	L12	GPIO
PE0	L13	GPIO (5V)	VREGVSS	L14	Voltage regulator VSS
PB0	M1	GPIO	PB1	M2	GPIO
PB4	M3	GPIO	PC0	M4	GPIO (5V)
PC3	M5	GPIO (5V)	PA9	M6	GPIO
BODEN	M7	Brown-Out Detector Enable. This pin may be left disconnected or tied to AVDD.	PA12	M8	GPIO (5V)
RESETn	M9	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB10	M10	GPIO (5V)
PD1	M11	GPIO	PC6	M12	GPIO
PD5	M13	GPIO	PD8	M14	GPIO
PB7	N1	GPIO	PB2	N2	GPIO
PB5	N3	GPIO	PC2	N4	GPIO (5V)
PC5	N5	GPIO	PA8	N6	GPIO
PA11	N7	GPIO	PA14	N8	GPIO
PB11	N9	GPIO	PB12	N10	GPIO
PD0	N11	GPIO (5V)	PD2	N12	GPIO (5V)
PD4	N13	GPIO	PD7	N14	GPIO
PB8	P1	GPIO	PB3	P2	GPIO
PB6	P3	GPIO	PC1	P4	GPIO (5V)
PC4	P5	GPIO	PA7	P6	GPIO
PA10	P7	GPIO	PA13	P8	GPIO (5V)
PB9	P9	GPIO (5V)	PB13	P10	GPIO
PB14	P11	GPIO	AVDD	P12	Analog power supply.
PD3	P13	GPIO	PD6	P14	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
VREGVDD	J13	Voltage regulator VDD input	PC0	K1	GPIO (5V)
PC1	K2	GPIO (5V)	PE0	K12	GPIO (5V)
VREGSW	K13	DCDC regulator switching node	PC2	L1	GPIO (5V)
PC3	L2	GPIO (5V)	PA7	L3	GPIO
PB9	L13	GPIO (5V)	PB10	L14	GPIO (5V)
PD1	L17	GPIO	PC6	L18	GPIO
PC7	L19	GPIO	VREGVSS	L20	Voltage regulator VSS
PB7	M1	GPIO	PC4	M2	GPIO
PA8	M3	GPIO	PA10	M4	GPIO
PA13	M5	GPIO (5V)	PA14	M6	GPIO
RESETn	M7	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB12	M8	GPIO
PD0	M9	GPIO (5V)	PD2	M10	GPIO (5V)
PD3	M11	GPIO	PD4	M12	GPIO
PD8	M13	GPIO	PB8	N1	GPIO
PC5	N2	GPIO	PA9	N3	GPIO
PA11	N4	GPIO	PA12	N5	GPIO (5V)
PB11	N6	GPIO	BODEN	N7	Brown-Out Detector Enable. This pin may be left disconnected or tied to AVDD.
PB13	N8	GPIO	PB14	N9	GPIO
AVDD	N10	Analog power supply.	PD5	N11	GPIO
PD6	N12	GPIO	PD7	N13	GPIO

**Note:**

1. GPIO with 5V tolerance are indicated by (5V).
2. The pins PD13, PD14, and PD15 will not be 5V tolerant on all future devices. In order to preserve upgrade options with full hardware compatibility, do not use these pins with 5V domains.

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PD15	J2	GPIO (5V)	PC6	J12	GPIO
DECOPULE	J13	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PC0	K1	GPIO (5V)
PC1	K2	GPIO (5V)	PD8	K13	GPIO
PC2	L1	GPIO (5V)	PC3	L2	GPIO (5V)
PA7	L3	GPIO	PB9	L15	GPIO (5V)
PB10	L16	GPIO (5V)	PD0	L17	GPIO (5V)
PD1	L18	GPIO	PD4	L19	GPIO
PD7	L20	GPIO	PB7	M1	GPIO
PC4	M2	GPIO	PA8	M3	GPIO
PA10	M4	GPIO	PA13	M5	GPIO (5V)
PA14	M6	GPIO	RESETn	M7	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.
AVDD	M9 M10 N11	Analog power supply.	PD3	M12	GPIO
PD6	M13	GPIO	PB8	N1	GPIO
PC5	N2	GPIO	PA9	N3	GPIO
PA11	N4	GPIO	PA12	N5	GPIO (5V)
PB11	N6	GPIO	PB12	N7	GPIO
PB13	N9	GPIO	PB14	N10	GPIO
PD2	N12	GPIO (5V)	PD5	N13	GPIO

**Note:**

1. GPIO with 5V tolerance are indicated by (5V).
2. The pins PD13, PD14, and PD15 will not be 5V tolerant on all future devices. In order to preserve upgrade options with full hardware compatibility, do not use these pins with 5V domains.

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PC4	13	GPIO	PC5	14	GPIO
PB7	15	GPIO	PB8	16	GPIO
PA8	17	GPIO	PA9	18	GPIO
PA10	19	GPIO	RESETn	20	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.
PB11	21	GPIO	AVDD	23 27	Analog power supply.
PB13	24	GPIO	PB14	25	GPIO
PD0	28	GPIO (5V)	PD1	29	GPIO
PD2	30	GPIO (5V)	PD3	31	GPIO
PD4	32	GPIO	PD5	33	GPIO
PD6	34	GPIO	PD7	35	GPIO
PD8	36	GPIO	PC6	37	GPIO
PC7	38	GPIO	DVDD	39	Digital power supply.
DECUPLE	40	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PC8	41	GPIO (5V)
PC9	42	GPIO (5V)	PC10	43	GPIO (5V)
PC11	44	GPIO (5V)	PC12	45	GPIO (5V)
PC13	46	GPIO (5V)	PC14	47	GPIO (5V)
PC15	48	GPIO (5V)	PF0	49	GPIO (5V)
PF1	50	GPIO (5V)	PF2	51	GPIO
PF3	52	GPIO	PF4	53	GPIO
PF5	54	GPIO	PE8	57	GPIO
PE9	58	GPIO	PE10	59	GPIO
PE11	60	GPIO	PE12	61	GPIO
PE13	62	GPIO	PE14	63	GPIO
PE15	64	GPIO			

**Note:**

1. GPIO with 5V tolerance are indicated by (5V).

## 5.17 EFM32GG11B5xx in QFN64 Device Pinout

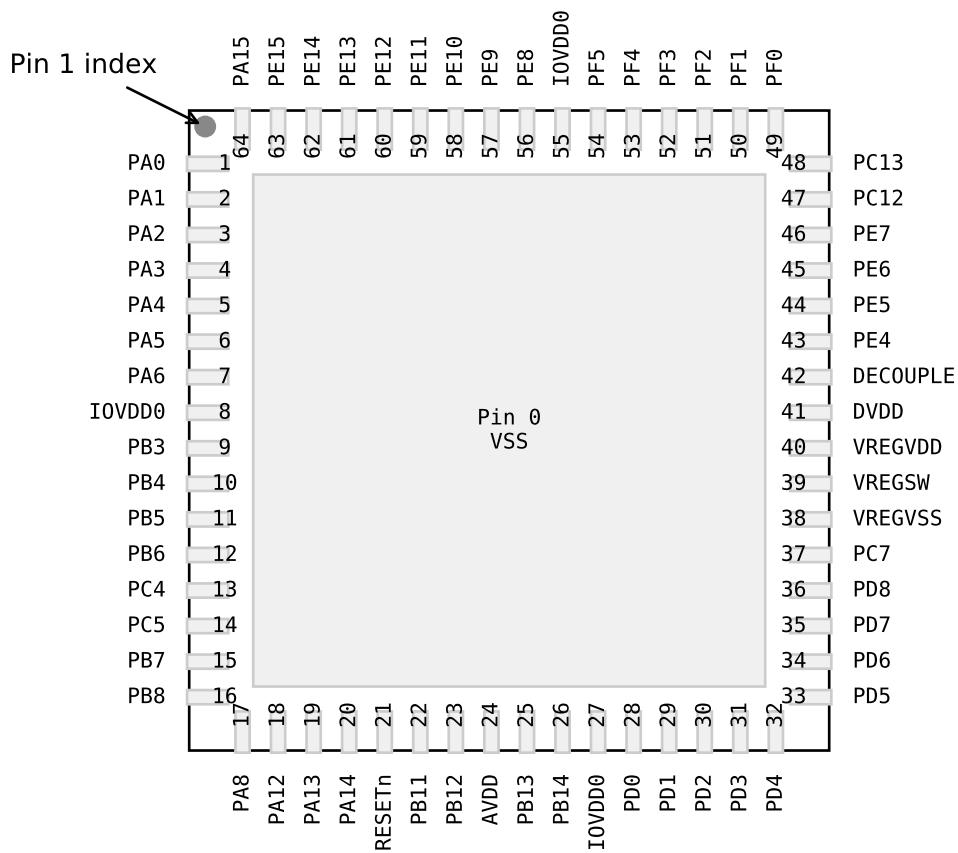


Figure 5.17. EFM32GG11B5xx in QFN64 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.17. EFM32GG11B5xx in QFN64 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
VSS	0	Ground	PA0	1	GPIO
PA1	2	GPIO	PA2	3	GPIO
PA3	4	GPIO	PA4	5	GPIO
PA5	6	GPIO	PA6	7	GPIO
IOVDD0	8 27 55	Digital IO power supply 0.	PB3	9	GPIO
PB4	10	GPIO	PB5	11	GPIO

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PG3	BUSACMP2Y BU-SACMP2X	EBI_AD03 #2	TIM6_CDTI0 #0 WTIM0_CC1 #2 LE-TIM1_OUT1 #7	ETH_MIITXD1 #1 US3_CS #4 QSPI0_DQ2 #2	
PI5		EBI_A07 #2	WTIM3_CC2 #4	US4_RTS #2 I2C2_SCL #7	ACMP3_O #5
PI4		EBI_A06 #2	WTIM3_CC1 #4	US4_CTS #2 I2C2_SDA #7	ACMP3_O #4
PI3		EBI_A05 #2	WTIM3_CC0 #4	US4_CS #2 I2C1_SCL #7	
PA5	BUSAY BUSBX LCD_SEG18	EBI_AD14 #0	TIM0_CDTI2 #0 TIM3_CC2 #5 PCNT1_S0IN #0	ETH_RMIIRXER #0 ETH_MIITXEN #0 SDIO_DAT5 #1 US3_RTS #0 U0_CTS #2 QSPI0_DQ3 #1 LEU1_TX #1	LES_ALTEX4 PRS_CH17 #0 ACMP1_O #7 ETM_TD3 #3
PG6	BUSACMP2Y BU-SACMP2X	EBI_AD06 #2	TIM2_CC1 #7 TIM6_CC0 #1	ETH_MIITXER #1 US3_TX #3 QSPI0_DQ5 #2	
PG5	BUSACMP2Y BU-SACMP2X	EBI_AD05 #2	TIM6_CDTI2 #0 TIM2_CC0 #7	ETH_MIITXEN #1 US3_RTS #4 QSPI0_DQ4 #2	
PI2		EBI_A04 #2	TIM5_CC2 #3 WTIM1_CC3 #5 PCNT2_S0IN #5	US4_CLK #2 I2C1_SDA #7	ACMP2_O #5
PI1		EBI_A03 #2	TIM5_CC1 #3 WTIM1_CC2 #5 PCNT2_S1IN #5	US4_RX #2	ACMP2_O #4
PI0		EBI_A02 #2	TIM5_CC0 #3 WTIM1_CC1 #5 PCNT2_S0IN #6	US4_TX #2	ACMP2_O #3
PA6	BUSBY BUSAX LCD_SEG19	EBI_AD15 #0	TIM3_CC0 #6 WTIM0_CC0 #1 LE-TIM1_OUT1 #0 PCNT1_S1IN #0	ETH_MIITXER #0 ETH_MDC #3 SDIO_CD #2 US5_TX #1 U0_RTS #2 LEU1_RX #1	PRS_CH6 #0 ACMP0_O #4 ETM_TCLK #3 GPIO_EM4WU1
PG8		EBI_AD08 #2	TIM2_CC0 #6 TIM6_CC2 #1 WTIM0_CC0 #3	ETH_MIIRXD3 #1 CAN0_RX #4 US3_CLK #3 QSPI0_DQ7 #2	
PG7	BUSACMP2Y BU-SACMP2X	EBI_AD07 #2	TIM2_CC2 #7 TIM6_CC1 #1	ETH_MIIRXCLK #1 US3_RX #3 QSPI0_DQ6 #2	
PE5	BUSCY BUSDX LCD_COM1	EBI_A12 #0 EBI_A17 #1 EBI_A23 #3	TIM3_CC0 #3 TIM3_CC2 #2 TIM5_CC1 #0 TIM6_CDTI1 #2 WTIM0_CC1 #0 WTIM1_CC2 #4	US0_CLK #1 US1_CLK #6 US3_CTS #1 U1_RTS #3 I2C0_SCL #7	PRS_CH17 #2

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PD4	BUSADC0Y BU-SADC0X OPA2_P	EBI_A08 #1 EBI_A17 #3	TIM6_CC0 #7 WTIM0_CDTI0 #4 WTIM1_CC2 #1 WTIM2_CC1 #5	CAN1_TX #2 US1_CTS #1 US3_CLK #2 LEU0_TX #0 I2C1_SDA #3	CMU_CLKI0 #0 PRS_CH10 #2 ETM_TD2 #0 ETM_TD2 #2
PC0	VDAC0_OUT0ALT / OPA0_OUTALT #0 BUSACMP0Y BU-SACMP0X	EBI_AD07 #1 EBI_CS0 #2 EBI_REn #3 EBI_A23 #0	TIM0_CC1 #3 TIM2_CC1 #4 PCNT0_S0IN #2	ETH_MDIO #2 CAN0_RX #0 US0_TX #5 US1_TX #0 US1_CS #4 US2 RTS #0 US3_CS #3 I2C0_SDA #4	LES_CH0 PRS_CH2 #0
PC1	VDAC0_OUT0ALT / OPA0_OUTALT #1 BUSACMP0Y BU-SACMP0X	EBI_AD08 #1 EBI_CS1 #2 EBI_BL0 #3 EBI_A24 #0	TIM0_CC2 #3 TIM2_CC2 #4 WTIM0_CC0 #7 PCNT0_S1IN #2	ETH_MDC #2 CAN0_TX #0 US0_RX #5 US1_TX #4 US1_RX #0 US2_CTS #0 US3_RTS #1 I2C0_SCL #4	LES_CH1 PRS_CH3 #0
PC2	VDAC0_OUT0ALT / OPA0_OUTALT #2 BUSACMP0Y BU-SACMP0X	EBI_AD09 #1 EBI_CS2 #2 EBI_NANDWE #3 EBI_A25 #0	TIM0_CDTI0 #3 TIM2_CC0 #5 WTIM0_CC1 #7 LE-TIM1_OUT0 #3	ETH_TSUEXTCLK #2 CAN1_RX #0 US1_RX #4 US2_TX #0	LES_CH2 PRS_CH10 #1
PA8	BUSBY BUSAX LCD SEG36	EBI_AD14 #1 EBI_A02 #3 EBI_DCLK #0	TIM2_CC0 #0 TIM0_CC0 #6 LE-TIM0_OUT0 #6 PCNT1_S1IN #4	US2_RX #2 US4_RTS #0	PRS_CH8 #0
PA11	BUSAY BUSBX LCD SEG39	EBI_CS1 #1 EBI_A05 #3 EBI_HSNC #0	WTIM2_CC2 #0 LE-TIM1_OUT0 #1	US2_CTS #2	PRS_CH11 #0
PA13	BUSAY BUSBX	EBI_WEn #1 EBI_NANDWE #2 EBI_A01 #0 EBI_A07 #3	TIM0_CC2 #7 TIM2_CC1 #1 WTIM0_CDTI1 #2 WTIM2_CC1 #1 LE-TIM1_OUT1 #1 PCNT1_S1IN #5	CAN1_TX #5 US0_CS #5 US2_TX #3	PRS_CH13 #0
PB9	BUSAY BUSBX	EBI_ALE #1 EBI_NANDRE #2 EBI_A00 #1 EBI_A03 #0 EBI_A09 #3	WTIM2_CC0 #2 LE-TIM0_OUT0 #7	SDIO_WP #3 CAN0_RX #3 US1_CTS #0 U1_TX #2	PRS_CH13 #1 ACMP1_O #5
PB12	BUSBY BUSAX VDAC0_OUT1 / OPA1_OUT	EBI_A03 #1 EBI_A12 #3 EBI_CSTFT #2	TIM1_CC3 #3 WTIM2_CC0 #3 LE-TIM0_OUT1 #1 PCNT0_S0IN #7 PCNT1_S1IN #6	US2_CTS #1 US5_RTS #0 U1_RTS #2 I2C1_SCL #1	PRS_CH16 #1
PH2	BUSADC1Y BU-SADC1X	EBI_VSNC #2	TIM6_CC0 #3	US1_CTS #6	
PH5	BUSADC1Y BU-SADC1X	EBI_A17 #2	TIM6_CDTI0 #3 WTIM2_CC1 #6	US4_RX #4	
PH8	BUSACMP3Y BU-SACMP3X	EBI_A20 #2	TIM6_CC0 #4 WTIM1_CC0 #6 WTIM2_CC1 #7	US4_CTS #4	

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
ETH_MDIO	0: PB3 1: PD13 2: PC0 3: PA15		Ethernet Management Data I/O.
ETH_MIICOL	0: PB2 1: PG15 2: PB4		Ethernet MII Collision Detect.
ETH_MIICRS	0: PB1 1: PG14 2: PB3		Ethernet MII Carrier Sense.
ETH_MIIRXCLK	0: PA15 1: PG7 2: PD12		Ethernet MII Receive Clock.
ETH_MIIRXD0	0: PE12 1: PG11 2: PF9		Ethernet MII Receive Data Bit 0.
ETH_MIIRXD1	0: PE13 1: PG10 2: PD9		Ethernet MII Receive Data Bit 1.
ETH_MIIRXD2	0: PE14 1: PG9 2: PD10		Ethernet MII Receive Data Bit 2.
ETH_MIIRXD3	0: PE15 1: PG8 2: PD11		Ethernet MII Receive Data Bit 3.
ETH_MIIRXDV	0: PE11 1: PG12 2: PF8		Ethernet MII Receive Data Valid.
ETH_MIIRXER	0: PE10 1: PG13 2: PF7		Ethernet MII Receive Error.
ETH_MIITXCLK	0: PA0 1: PG0		Ethernet MII Transmit Clock.
ETH_MIITXD0	0: PA4 1: PG4		Ethernet MII Transmit Data Bit 0.
ETH_MIITXD1	0: PA3 1: PG3		Ethernet MII Transmit Data Bit 1.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
LCD_BEXT	0: PA14		<p>LCD external supply bypass in step down or charge pump mode. If using the LCD in step-down or charge pump mode, a 1 uF (minimum) capacitor between this pin and VSS is required.</p> <p>To reduce supply ripple, a larger capacitor of approximately 1000 times the total LCD segment capacitance may be used.</p> <p>If using the LCD with the internal supply source, this pin may be left unconnected or used as a GPIO.</p>
LCD_COM0	0: PE4		LCD driver common line number 0.
LCD_COM1	0: PE5		LCD driver common line number 1.
LCD_COM2	0: PE6		LCD driver common line number 2.
LCD_COM3	0: PE7		LCD driver common line number 3.
LCD_SEG0	0: PF2		LCD segment line 0.
LCD_SEG1	0: PF3		LCD segment line 1.
LCD_SEG2	0: PF4		LCD segment line 2.
LCD_SEG3	0: PF5		LCD segment line 3.
LCD_SEG4	0: PE8		LCD segment line 4.
LCD_SEG5	0: PE9		LCD segment line 5.
LCD_SEG6	0: PE10		LCD segment line 6.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
LCD_SEG20 / LCD_COM4	0: PB3		LCD segment line 20. This pin may also be used as LCD COM line 4
LCD_SEG21 / LCD_COM5	0: PB4		LCD segment line 21. This pin may also be used as LCD COM line 5
LCD_SEG22 / LCD_COM6	0: PB5		LCD segment line 22. This pin may also be used as LCD COM line 6
LCD_SEG23 / LCD_COM7	0: PB6		LCD segment line 23. This pin may also be used as LCD COM line 7
LCD_SEG24	0: PF6		LCD segment line 24.
LCD_SEG25	0: PF7		LCD segment line 25.
LCD_SEG26	0: PF8		LCD segment line 26.
LCD_SEG27	0: PF9		LCD segment line 27.
LCD_SEG28	0: PD9		LCD segment line 28.
LCD_SEG29	0: PD10		LCD segment line 29.
LCD_SEG30	0: PD11		LCD segment line 30.
LCD_SEG31	0: PD12		LCD segment line 31.
LCD_SEG32	0: PB0		LCD segment line 32.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
LCD_SEG33	0: PB1		LCD segment line 33.
LCD_SEG34	0: PB2		LCD segment line 34.
LCD_SEG35	0: PA7		LCD segment line 35.
LCD_SEG36	0: PA8		LCD segment line 36.
LCD_SEG37	0: PA9		LCD segment line 37.
LCD_SEG38	0: PA10		LCD segment line 38.
LCD_SEG39	0: PA11		LCD segment line 39.
LES_ALTEX0	0: PD6		LESENSE alternate excite output 0.
LES_ALTEX1	0: PD7		LESENSE alternate excite output 1.
LES_ALTEX2	0: PA3		LESENSE alternate excite output 2.
LES_ALTEX3	0: PA4		LESENSE alternate excite output 3.
LES_ALTEX4	0: PA5		LESENSE alternate excite output 4.
LES_ALTEX5	0: PE11		LESENSE alternate excite output 5.

Table 5.23. ACMP0 Bus and Pin Mapping

	APORT4Y	APORT4X	APORT3Y	APORT3X	APORT2Y	APORT2X	APORT1Y	APORT1X	APORT0Y	APORT0X	Port
BUSDY	BUSDX	BUSCY	BUSCX	BUSBY	BUSBX	BUSAY	BUSAX	BUSAY	BUSACMP0Y	BUSACMP0X	Bus
PF15	PF15				PB15						CH31
PF14		PF14		PF14			PB14				CH30
PF13	PF13				PB13	PB13					CH29
PF12		PF12		PF12			PB12				CH28
PF11	PF11				PB11	PB11					CH27
PF10		PF10		PF10			PB10	PB10			CH26
PF9	PF9				PB9	PB9					CH25
PF8		PF8									CH24
PF7	PF7										CH23
PF6		PF6		PF6	PB6		PB6				CH22
PF5	PF5				PB5	PB5	PB5				CH21
PF4		PF4		PF4	PB4		PB4				CH20
PF3	PF3				PB3	PB3	PB3				CH19
PF2		PF2		PF2	PB2		PB2				CH18
PF1	PF1				PB1	PB1	PB1				CH17
PF0		PF0		PF0	PB0		PB0				CH16
PE15	PE15				PA15	PA15	PA15				CH15
PE14		PE14		PE14	PA14		PA14				CH14
PE13	PE13				PA13	PA13	PA13				CH13
PE12		PE12		PE12	PA12		PA12				CH12
PE11	PE11				PA11	PA11	PA11				CH11
PE10		PE10		PE10	PA10		PA10				CH10
PE9	PE9				PA9	PA9	PA9				CH9
PE8		PE8		PE8	PA8		PA8				CH8
PE7	PE7				PA7	PA7	PA7				CH7
PE6		PE6		PE6	PA6		PA6	PA6	PC6	PC6	CH6
PE5	PE5				PA5	PA5	PA5	PA5	PC5	PC5	CH5
PE4		PE4		PE4	PA4		PA4	PA4	PC4	PC4	CH4
					PA3	PA3	PA3	PA3	PC3	PC3	CH3
					PA2		PA2	PA2	PC2	PC2	CH2
PE1	PE1				PA1	PA1	PA1	PA1	PC1	PC1	CH1
PE0		PE0		PE0	PA0		PA0	PA0	PC0	PC0	CH0

**Table 7.2. BGA152 PCB Land Pattern Dimensions**

Dimension	Min	Nom	Max
X		0.20	
C1		6.50	
C2		6.50	
E1		0.5	
E2		0.5	

**Note:**

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.
3. This Land Pattern Design is based on the IPC-7351 guidelines.
4. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.
5. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
6. The stencil thickness should be 0.125 mm (5 mils).
7. The ratio of stencil aperture to land pad size should be 1:1.
8. A No-Clean, Type-3 solder paste is recommended.
9. The recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

### 9.3 BGA112 Package Marking



**Figure 9.3. BGA112 Package Marking**

The package marking consists of:

- **PPPPPPPPPP** – The part number designation.
- **TTTTT** – A trace or manufacturing code. The first letter is the device revision.
- **YY** – The last 2 digits of the assembly year.
- **WW** – The 2-digit workweek when the device was assembled.